

# ORGALLOY®

## EM 067 HSP

Orgalloy® EM 067 HSP树脂 是一种柔韧的聚酰胺，用于空调橡胶软管中的制冷剂阻隔层。

### 包装

该牌号供货应规格为干燥型密封包装（20公斤袋装），可随时加工处理。

### 保质期

自发货之日起2年。有关过期使用的任何事宜，请咨询我司技术服务人员。

性能	干 / 已调节	单位	测试标准
<b>流变性能</b>			
熔体体积流动速度	1 / *	cm <sup>3</sup> /10min	ISO 1133
温度	235 / *	°C	-
	455 / *	°F	-
载荷	5 / *	kg	-
	11 / *	lb	-
<b>机械性能</b>			
拉伸模量	- / 572	MPa	ISO 527-1/-2
	- / 83000	psi	
50%伸长率时的应力S	- / 32	MPa	ISO 527-1/-2
	- / 4640	psi	
断裂伸长率	- / >50	%	ISO 527-1/-2
<b>热性能</b>			
熔融温度, 10°C/min	215 / *	°C	ISO 11357-1/-3
<b>其它性能</b>			
密度	1140 / 1140	kg/m <sup>3</sup>	ISO 1183
	1.14 / 1.14	g/cm <sup>3</sup>	

### 加工条件：

—干燥时间和温度（只有包装袋打开2小时以上时才有必要干燥）：

4-16小时，80-90°C

—挤出熔融温度（最小值-建议值-最大值）：240-260-300°C

# ORGALLOY<sup>®</sup>

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<b>加工方法</b> 薄膜挤出成型, 异型材挤出成型, 其它挤出成型	<b>Headquarters:</b> Arkema France 420 rue d'Estienne d'Orves 92705 Colombes Cedex France T +33 (0)1 49 00 80 80 hpp.arkema.com  Arkema Inc. – High Performance Polymers 900 First Avenue King of Prussia, PA 19406 Tel.: +1 610 205 7000 hpp.arkema.com
<b>供货形式</b> 粒料	
<b>添加剂</b> 增塑剂	
<b>地区供应</b> 北美, 欧洲, 亚太, 中南美洲, 中东/非洲	

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